

Taiwan Semiconductor

1A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Low power loss, high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

Δ	P	P	C	Δ	T	O	N	S

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

• Case: SOD-128

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Polarity: Indicated by cathode band

• Weight: 0.027g (approximately)

KEY PARAMETERS						
PARAMETER	VALUE	UNIT				
I _F	1	А				
V _{RRM}	200 - 1000	V				
I _{FSM}	30	Α				
T _J MAX	175	°C				
Package	SOD-128					
Configuration	Single die					









SOD-128



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	RS1D FSH	RS1G FSH	RS1J FSH	RS1K FSH	RS1M FSH	UNIT
Marking code on the device		RS1DFS	RS1GFS	RS1JFS	RS1KFS	RS1MFS	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	140	280	420	560	700	V
Forward current	l _F			1			Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	gle half sine-wave superimposed IFSM 30				А		
Junction temperature	TJ			-55 to +175	;		°C
Storage temperature	T _{STG}	-55 to +175					°C

Taiwan Semiconductor

THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance	R _{OJL}	29	°C/W			
Junction-to-ambient thermal resistance	Reja	84	°C/W			
Junction-to-case thermal resistance	Rejc	30	°C/W			

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
		I _F = 0.5A, T _J = 25°C		0.94	1.10	V
Converse valtage (1)		I _F = 1.0A, T _J = 25°C	V	1.01	1.30	V
Forward voltage ⁽¹⁾		I _F = 0.5A, T _J = 125°C	V _F	0.79	1.00	V
		I _F = 1.0A, T _J = 125°C		0.88	1.20	V
Doverse current @ reted \	' ₋ (2)	T _J = 25°C	I-	-	5	μΑ
Reverse current @ rated \	R(=)	T _J = 125°C	I _R	-	50	μΑ
Junction capacitance		1MHz, V _R = 4.0V	CJ	7	-	pF
	RS1DFSH RS1GFSH	I _F = 0.5A, I _R = 1.0A I _{rr} = 0.25A	trr	-	150	ns
Reverse recovery time	RS1JFSH			-	250	ns
	RS1KFSH RS1MFSH			-	500	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION							
ORDERING CODE(1)	PACKAGE	PACKING					
RS1xFSH	SOD-128	14,000 / Tape & Reel					

Notes:

1. "x" defines voltage from 200V(RS1DFSH) to 1000V(RS1MFSH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

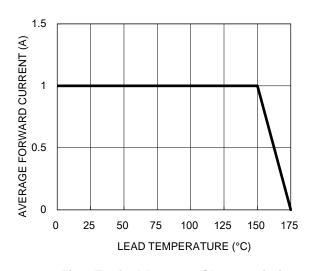


Fig.3 Typical Reverse Characteristics

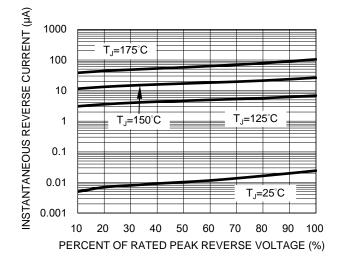


Fig.2 Typical Junction Capacitance

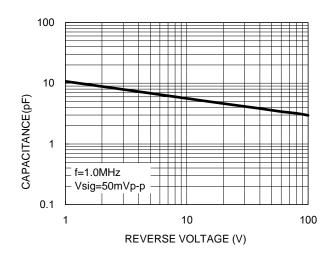
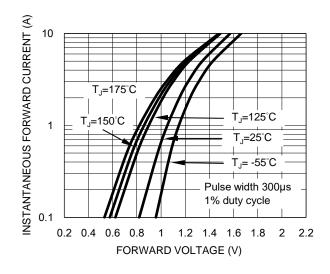


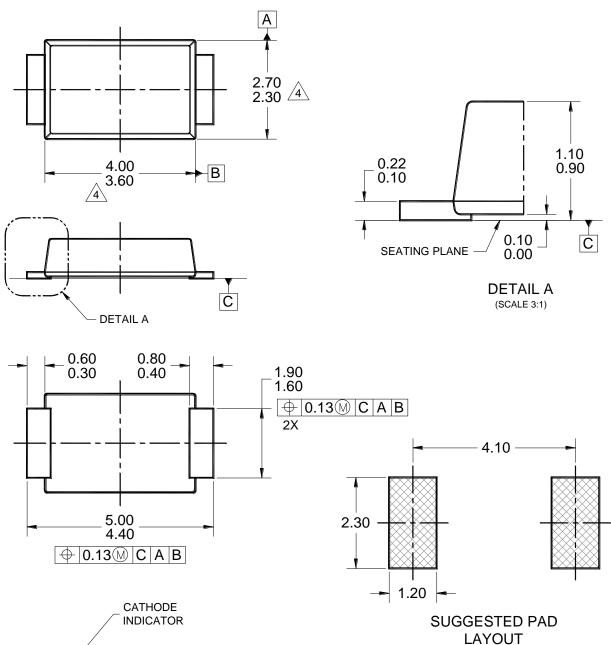
Fig.4 Typical Forward Characteristics

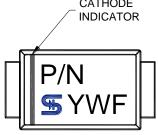




PACKAGE OUTLINE DIMENSIONS

SOD-128





MARKING DIAGRAM

P/N = MARKING CODE YW = DATE CODE

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AD, ISSUE B.
- MODED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- 5. DWG NO. REF: HQ2SD07-SOD128-039 REV A.

Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.